



**THE DATASHEET OF
74AUP1G09FW5-7**



Description

The Advanced, Ultra Low Power (AUP) CMOS logic family is designed for low power and extended battery life in portable applications.

The AUP1G09 is a single AND gate with an open drain output designed for operation over a power supply range of 0.8V to 3.6V. The device is fully specified for partial power down applications using I_{OFF}. The I_{OFF} circuitry disables the output preventing damaging current backflow when the device is powered down. The gate performs the positive Boolean function:

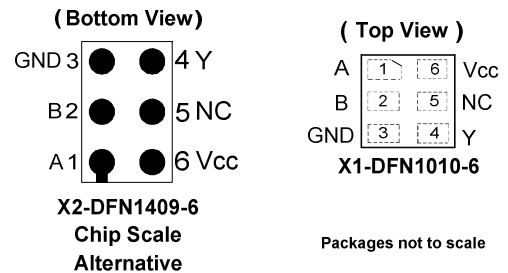
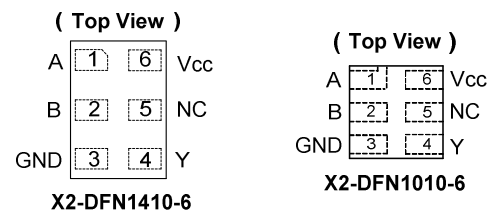
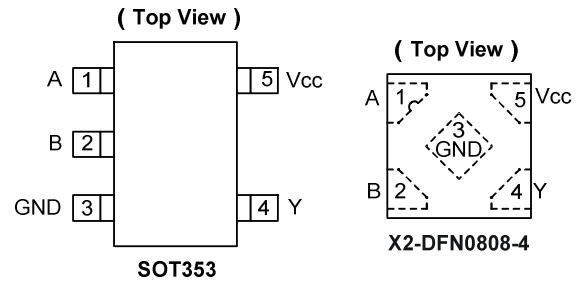
$$Y = A \cdot B \text{ or } Y = \overline{\overline{A + B}}$$

Features

- Advanced Ultra Low Power (AUP) CMOS
- Supply Voltage Range from 0.8V to 3.6V
- 4mA Output Drive at 3.0V
- Low Static Power Consumption
I_{CC} < 0.9µA
- Low Dynamic Power Consumption
C_{PD} = 6 pF (Typical at 3.6V)
- Schmitt Trigger Action at all inputs makes the circuit tolerant for slower input rise and fall time. The hysteresis is typically 250 mV at V_{CC} = 3.0V.
- I_{OFF} Supports Partial-Power-Down Mode Operation
- ESD Protection Exceeds JESD 22
2000-V Human Body Model (A114)
Exceeds 1000-V Charged Device Model (C101)
- Latch-Up Exceeds 100mA per JESD 78, Class I
- Leadless Packages Named per JESD30E
- **Totally Lead-Free & Fully RoHS Compliant (Notes 1 & 2)**
- **Halogen and Antimony Free. "Green" Device (Note 3)**

- Notes:
1. No purposely added lead. Fully EU Directive 2002/95/EC (RoHS) & 2011/65/EU (RoHS 2) compliant.
 2. See http://www.diodes.com/quality/lead_free.html for more information about Diodes Incorporated's definitions of Halogen- and Antimony-free, "Green" and Lead-free.
 3. Halogen- and Antimony-free "Green" products are defined as those which contain <900ppm bromine, <900ppm chlorine (<1500ppm total Br + Cl) and <1000ppm antimony compounds.

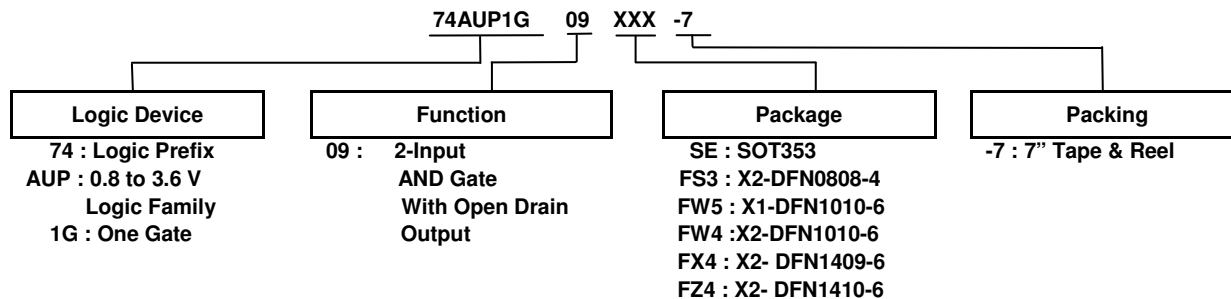
Pin Assignments



Applications

- Suited for Battery and Low Power Needs
- Wide array of products such as:
 - Tablets, E-readers
 - Cell Phones, Personal Navigation / GPS
 - MP3 Players, Cameras, Video Recorders
 - PCs, Ultrabooks, Notebooks, Netbooks
 - Computer Peripherals, Hard Drives, SSDs, CD/DVD ROMs
 - TVs, DVDs, DVRs, Set-Top Boxes

Ordering Information



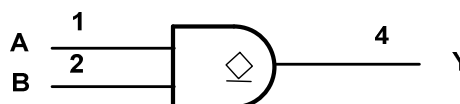
| Device | Package Code | Package (Notes 4 & 5) | Package Size | 7" Tape and Reel | |
|----------------|--------------|--|--|-------------------|--------------------|
| | | | | Quantity | Part Number Suffix |
| 74AUP1G09SE-7 | SE | SOT353 | 2.0mm x 2.0mm x 1.1mm 0.65 mm lead pitch | 3,000/Tape & Reel | -7 |
| 74AUP1G09FS3-7 | FS3 | X2-DFN0808-4 | 0.8mm x 0.8mm x 0.35mm 0.5 mm pad pitch (diamond) | 5,000/Tape & Reel | -7 |
| 74AUP1G09FW5-7 | FW5 | X1-DFN1010-6 | 1.0mm x 1.0mm x 0.5mm 0.35 mm pad pitch | 5,000/Tape & Reel | -7 |
| 74AUP1G09FW4-7 | FW4 | X2-DFN1010-6 | 1.0mm x 1.0mm x 0.4mm 0.35 mm pad pitch | 5,000/Tape & Reel | -7 |
| 74AUP1G09FX4-7 | FX4 | X2-DFN1409-6 Chip Scale Alternative | 1.4mm x 0.9mm x 0.4mm 0.5 mm pad pitch | 5,000/Tape & Reel | -7 |
| 74AUP1G09FZ4-7 | FZ4 | X2-DFN1410-6 | 1.4mm x 1.0mm x 0.4mm 0.5 mm pad pitch | 5,000/Tape & Reel | -7 |

Notes: 4. Pad layout as shown on Diodes Inc. suggested pad layout document AP02001, which can be found on our website at <http://www.diodes.com/datasheets/ap02001.pdf>.
5. The taping orientation is located on our website at <http://www.diodes.com/datasheets/ap02007.pdf>.

Pin Descriptions

| Pin Name | Function |
|----------|----------------|
| A | Data Input |
| B | Data Input |
| GND | Ground |
| Y | Data Output |
| Vcc | Supply Voltage |

Logic Diagram



Function Table

| Inputs | | Output |
|--------|---|--------|
| A | B | Y |
| L | L | L |
| L | H | L |
| H | L | L |
| H | H | Z |

Absolute Maximum Ratings (Notes 6 & 7) (@ $T_A = +25^\circ\text{C}$, unless otherwise specified.)

| Symbol | Parameter | Rating | Unit |
|-----------|---|--------------|------------------|
| ESD HBM | Human Body Model ESD Protection | 2 | kV |
| ESD CDM | Charged Device Model ESD Protection | 1 | kV |
| V_{CC} | Supply Voltage Range | -0.5 to +4.6 | V |
| V_I | Input Voltage Range | -0.5 to +4.6 | V |
| V_O | Voltage applied to output in High or Low State | -0.5 to +4.6 | V |
| I_{IK} | Input Clamp Current $V_I < 0$ | 50 | mA |
| I_{OK} | Output Clamp Current ($V_O < 0$) | 50 | mA |
| I_O | Continuous Output Current ($V_O = 0$ to V_{CC}) | ± 20 | mA |
| I_{CC} | Continuous Current Through V_{CC} | 50 | mA |
| I_{GND} | Continuous Current Through GND | -50 | mA |
| T_J | Operating Junction Temperature | -40 to +150 | $^\circ\text{C}$ |
| T_{STG} | Storage Temperature | -65 to +150 | $^\circ\text{C}$ |

- Notes:
- Stresses beyond the absolute maximum may result in immediate failure or reduced reliability. These are stress values and device operation should be within recommend values.
 - Forcing the maximum allowed voltage could cause a condition exceeding the maximum current or conversely forcing the maximum current could cause a condition exceeding the maximum voltage. The ratings of both current and voltage must be maintained within the controlled range.

Recommended Operating Conditions (Note 8) (@ $T_A = +25^\circ\text{C}$, unless otherwise specified.)

| Symbol | Parameter | Min | Max | Unit | | |
|---------------------|------------------------------------|---|-----|------------------|---------------|------|
| V_{CC} | Operating Voltage | 0.8 | 3.6 | V | | |
| V_I | Input Voltage | 0 | 3.6 | V | | |
| V_O | Output Voltage | 0 | 3.6 | V | | |
| I_{OL} | Low-Level Output Current | $V_{CC} = 0.8\text{V}$ | — | 20 | μA | |
| | | $V_{CC} = 1.1\text{V}$ | — | 1.1 | mA | |
| | | $V_{CC} = 1.4\text{V}$ | — | 1.7 | | |
| | | $V_{CC} = 1.65\text{V}$ | — | 1.9 | | |
| | | $V_{CC} = 2.3\text{V}$ | — | 3.1 | | |
| | | $V_{CC} = 3.0\text{V}$ | — | 4 | | |
| $\Delta t/\Delta V$ | Input Transition Rise or Fall Rate | $V_{CC} = 0.8\text{V}$ to 3.6V | | — | 200 | ns/V |
| T_A | Operating Free-Air Temperature | -40 | 125 | $^\circ\text{C}$ | | |

- Note: 8. Unused inputs should be held at V_{CC} or Ground.

Electrical Characteristics (@T_A = +25°C, unless otherwise specified.)

| Symbol | Parameter | Test Conditions | V _{CC} | T _A = +25°C | | T _A = -40°C to +85°C | | Unit |
|-------------------|----------------------------------|---|-----------------|------------------------|------------------------|---------------------------------|------------------------|------|
| | | | | Min | Max | Min | Max | |
| V _{IH} | High-Level Input Voltage | — | 0.8V to 1.65V | 0.80 x V _{CC} | — | 0.80 x V _{CC} | — | V |
| | | — | 1.65V to 1.95V | 0.65 x V _{CC} | — | 0.65 x V _{CC} | — | |
| | | — | 2.3V to 2.7V | 1.6 | — | 1.6 | — | |
| | | — | 3.0V to 3.6V | 2.0 | — | 2.0 | — | |
| V _{IL} | Low-Level Input voltage | — | 0.8V to 1.65V | — | 0.30 x V _{CC} | — | 0.30 x V _{CC} | V |
| | | — | 1.65V to 1.95V | — | 0.35 x V _{CC} | — | 0.35 x V _{CC} | |
| | | — | 2.3V to 2.7V | — | 0.7 | — | 0.7 | |
| | | — | 3.0V to 3.6V | — | 0.9 | — | 0.9 | |
| V _{OL} | Low-Level Output Voltage | I _{OL} = 20μA | 0.8V to 3.6V | — | 0.1 | — | 0.1 | V |
| | | I _{OL} = 1.1mA | 1.1V | — | 0.3 x V _{CC} | — | 0.3 x V _{CC} | |
| | | I _{OL} = 1.7mA | 1.4V | — | 0.31 | — | 0.37 | |
| | | I _{OL} = 1.9mA | 1.65V | — | 0.31 | — | 0.35 | |
| | | I _{OL} = 2.3mA | 2.3V | — | 0.31 | — | 0.33 | |
| | | I _{OL} = 3.1mA | | — | 0.44 | — | 0.45 | |
| | | I _{OL} = 2.7mA | 3V | — | 0.31 | — | 0.33 | |
| | | I _{OL} = 4mA | | — | 0.44 | — | 0.45 | |
| I _I | Input Current | A or B Input V _I = GND to 3.6V | 0V to 3.6V | — | ± 0.1 | — | ± 0.5 | μA |
| I _{OFF} | Power Down Leakage Current | V _I or V _O = 0V to 3.6V | 0 | — | ± 0.2 | — | ± 0.5 | μA |
| I _{OZ} | Z State Leakage Current | V _O = 3.6V V _I = 3.6V | 3.6V | — | ± 0.2 | — | ± 0.5 | μA |
| ΔI _{OFF} | Delta Power Down Leakage Current | V _I or V _O = 0V to 3.6V | 0V to 0.2V | — | 0.2 | — | 0.6 | μA |
| I _{CC} | Supply Current | V _I = GND or V _{CC} I _O = 0 | 0.8V to 3.6V | — | 0.5 | — | 0.9 | μA |
| ΔI _{CC} | Additional Supply Current | Input at V _{CC} -0.6V | 3.3V | — | 40 | — | 50 | μA |

Electrical Characteristics (continued) (@T_A = +25°C, unless otherwise specified.)

| Symbol | Parameter | Test Conditions | V _{CC} | T _A = -40°C to +125°C | | Unit |
|-------------------|----------------------------------|--|-----------------|----------------------------------|------------------------|------|
| | | | | Min | Max | |
| V _{IH} | High-Level Input Voltage | — | 0.8V to 1.65V | 0.80 x V _{CC} | — | V |
| | | — | 1.65V to 1.95V | 0.70 x V _{CC} | — | |
| | | — | 2.3V to 2.7V | 1.6 | — | |
| | | — | 3.0V to 3.6V | 2.0 | — | |
| V _{IL} | Low-Level Input Voltage | — | 0.8V to 1.65V | — | 0.25 x V _{CC} | V |
| | | — | 1.65V to 1.95V | — | 0.35 x V _{CC} | |
| | | — | 2.3V to 2.7V | — | 0.7 | |
| | | — | 3.0V to 3.6V | — | 0.9 | |
| V _{OL} | Low-Level Output Voltage | I _{OL} = 20 μA | 0.8V to 3.6V | — | 0.11 | V |
| | | I _{OL} = 1.1 mA | 1.1V | — | 0.3 x V _{CC} | |
| | | I _{OL} = 1.7 mA | 1.4V | — | 0.41 | |
| | | I _{OL} = 1.9 mA | 1.65V | — | 0.39 | |
| | | I _{OL} = 2.3 mA | 2.3V | — | 0.36 | |
| | | I _{OL} = 3.1 mA | | — | 0.50 | |
| | | I _{OL} = 2.7 mA | 3V | — | 0.36 | |
| | | I _{OL} = 4 mA | | — | 0.50 | |
| I _I | Input Current | A or B Input V _I = GND to 3.6V | 0V to 3.6V | — | ± 0.75 | μA |
| I _{OFF} | Power Down Leakage Current | V _I or V _O = 0V to 3.6V | 0 | — | ± 3.5 | μA |
| I _{OZ} | Z State Leakage Current | V _O = 3.6V V _I = 3.6V | 3.6V | — | ± 1.5 | μA |
| ΔI _{OFF} | Delta Power Down Leakage Current | V _I or V _O = 0V to 3.6V | 0V to 0.2V | — | ± 2.5 | μA |
| I _{CC} | Supply Current | V _I = GND or V _{CC} , I _O = 0 | 0.8V to 3.6V | — | 3.0 | μA |
| ΔI _{CC} | Additional Supply Current | Input at V _{CC} -0.6V | 3.3V | — | 75 | μA |

Switching Characteristics

 $C_L=5\text{pF}$, See Figure 1

| Parameter | From Input | TO OUTPUT | V _{CC} | T _A = +25°C | | | T _A = -40°C to +85°C | | T _A = -40°C to +125°C | | Unit |
|-----------------|------------|-----------|-----------------|------------------------|------|------|---------------------------------|------|----------------------------------|------|------|
| | | | | Min | Typ | Max | Min | Max | Min | Max | |
| t _{pd} | A | Y | 0.8V | — | 13.5 | — | — | — | — | — | ns |
| | | | 1.2V ± 0.1V | 1.9 | 4.6 | 10.4 | 1.8 | 11.4 | 1.8 | 12.6 | |
| | | | 1.5V ± 0.1V | 1.5 | 3.3 | 6.5 | 1.4 | 7.4 | 1.4 | 8.2 | |
| | | | 1.8V ± 0.15V | 1.2 | 2.9 | 5.1 | 1.1 | 5.9 | 1.1 | 6.5 | |
| | | | 2.5V ± 0.2V | 1.0 | 2.4 | 4.4 | 0.9 | 4.6 | 0.9 | 4.9 | |
| | | | 3.3V ± 0.3V | 0.9 | 2.3 | 4.0 | 0.8 | 4.5 | 0.8 | 4.9 | |

 $C_L=10\text{pF}$, See Figure 1

| Parameter | From Input | TO OUTPUT | V _{CC} | T _A = +25°C | | | T _A = -40°C to +85°C | | T _A = -40°C to +125°C | | Unit |
|-----------------|------------|-----------|-----------------|------------------------|------|------|---------------------------------|------|----------------------------------|------|------|
| | | | | Min | Typ | Max | Min | Max | Min | Max | |
| t _{pd} | A | Y | 0.8V | — | 16.3 | — | — | — | — | — | ns |
| | | | 1.2V ± 0.1V | 2.3 | 5.6 | 12.3 | 2.1 | 13.7 | 2.1 | 15.1 | |
| | | | 1.5V ± 0.1V | 1.8 | 4.1 | 7.6 | 1.7 | 8.8 | 1.7 | 9.7 | |
| | | | 1.8V ± 0.15V | 1.6 | 3.2 | 7.3 | 1.4 | 7.1 | 1.4 | 7.0 | |
| | | | 2.5V ± 0.2V | 1.4 | 2.9 | 6.1 | 1.2 | 6.4 | 1.2 | 5.9 | |
| | | | 3.3V ± 0.3V | 1.3 | 2.9 | 5.7 | 1.1 | 5.4 | 1.1 | 5.9 | |

 $C_L=15\text{pF}$, See Figure 1

| Parameter | From Input | TO OUTPUT | V _{CC} | T _A = +25°C | | | T _A = -40°C to +85°C | | T _A = -40°C to +125°C | | Unit |
|-----------------|------------|-----------|-----------------|------------------------|------|------|---------------------------------|------|----------------------------------|------|------|
| | | | | Min | Typ | Max | Min | Max | Min | Max | |
| t _{pd} | A | Y | 0.8V | — | 19.0 | — | — | — | — | — | ns |
| | | | 1.2V ± 0.1V | 2.6 | 7.6 | 14.2 | 2.4 | 15.8 | 2.4 | 17.4 | |
| | | | 1.5V ± 0.1V | 2.1 | 6.5 | 12.1 | 1.9 | 12.7 | 1.9 | 12.9 | |
| | | | 1.8V ± 0.15V | 1.9 | 5.5 | 9.6 | 1.7 | 10.1 | 1.7 | 10.3 | |
| | | | 2.5V ± 0.2V | 1.6 | 4.6 | 8.1 | 1.5 | 9.1 | 1.5 | 9.3 | |
| | | | 3.3V ± 0.3V | 1.6 | 4.1 | 7.5 | 1.4 | 8.3 | 1.4 | 9.1 | |

 $C_L=30\text{pF}$, See Figure 1

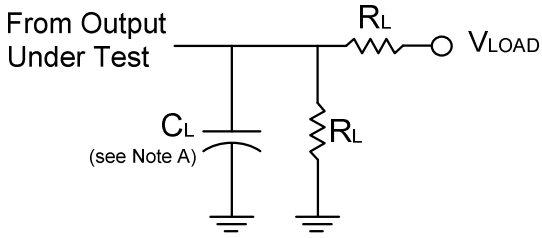
| Parameter | From Input | TO OUTPUT | V _{CC} | T _A = +25°C | | | T _A = -40°C to +85°C | | T _A = -40°C to +125°C | | Unit |
|-----------------|------------|-----------|-----------------|------------------------|-----|------|---------------------------------|------|----------------------------------|------|------|
| | | | | Min | Typ | Max | Min | Max | Min | Max | |
| t _{pd} | A | Y | 0.8V | — | 27 | — | — | — | — | — | ns |
| | | | 1.2V ± 0.1V | 3.6 | 9.5 | 19.5 | 3.2 | 21.8 | 3.2 | 24 | |
| | | | 1.5V ± 0.1V | 2.9 | 8.5 | 16.1 | 2.6 | 13.6 | 2.6 | 15 | |
| | | | 1.8V ± 0.15V | 2.6 | 7.7 | 15.2 | 2.3 | 13.3 | 2.3 | 14.6 | |
| | | | 2.5V ± 0.2V | 2.4 | 7 | 13.1 | 2.1 | 13.3 | 2.1 | 13.5 | |
| | | | 3.3V ± 0.3V | 2.3 | 6.5 | 12.7 | 2.1 | 12.9 | 2.1 | 12.9 | |

Operating and Package Characteristics (@T_A = +25 °C, unless otherwise specified.)

| Parameter | | Test Conditions | | V _{CC} | Typ | Unit |
|-----------------|--|---|----------|-----------------|-----|------|
| C _{pd} | Power Dissipation Capacitance | f = 1MHz No Load | | 0.8V | 6.5 | pF |
| | | | | 1.2V ± 0.1V | 6.3 | |
| | | | | 1.5V ± 0.1V | 6.3 | |
| | | | | 1.8V ± 0.15V | 6.2 | |
| | | | | 2.5V ± 0.2V | 6.2 | |
| | | | | 3.3V ± 0.3V | 6.1 | |
| C _i | Input Capacitance | V _i = V _{CC} or GND | | 0V or 3.3V | 1.5 | pF |
| θ _{JA} | Thermal Resistance Junction-to-Ambient | SOT353 | (Note 9) | — | 371 | °C/W |
| | | X2-DFN0808-4 | | — | 430 | |
| | | X1-DFN1010-6 | | — | 435 | |
| | | X2-DFN1010-6 | | — | 445 | |
| | | X2-DFN1409-6 | | — | 470 | |
| | | X2-DFN1410-6 | | — | 460 | |
| θ _{JC} | Thermal Resistance Junction-to-Case | SOT353 | (Note 9) | — | 143 | °C/W |
| | | X2-DFN0808-4 | | — | 240 | |
| | | X1-DFN1010-6 | | — | 250 | |
| | | X2-DFN1010-6 | | — | 250 | |
| | | X2-DFN1409-6 | | — | 275 | |
| | | X2-DFN1410-6 | | — | 265 | |

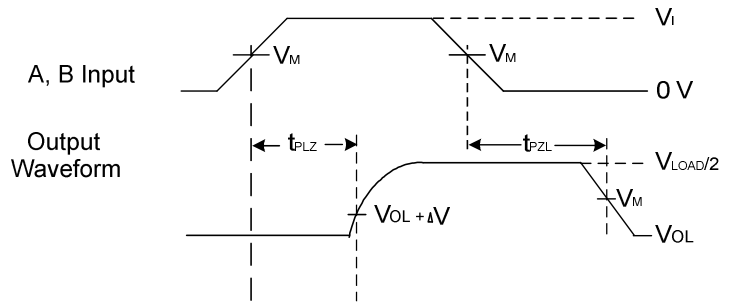
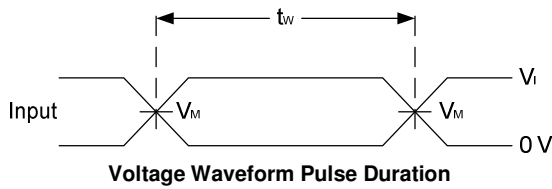
Note: 9. Test condition for each of the six package types: Device mounted on FR-4 substrate PC board, 2oz copper, with minimum recommended pad layout.

Parameter Measurement Information



| TEST | Condition |
|-------------------------------|-----------|
| t_{PLZ} (see Notes D and E) | Vload |
| t_{PZL} (see Notes D and F) | Vload |

| Vcc | Inputs | | VM | VLOAD | CL | RL | VΔ |
|--------------|--------|-------|-------|---------|------------------|-----|-------|
| | VI | tr/td | | | | | |
| 0.8 V | Vcc | ≤3ns | Vcc/2 | 2 X Vcc | 5, 10, 15, 30 pF | 5KΩ | 0.1V |
| 1.2 V±0.1 V | Vcc | ≤3ns | Vcc/2 | 2 X Vcc | 5, 10, 15, 30 pF | 5KΩ | 0.1V |
| 1.5 V±0.1 V | Vcc | ≤3ns | Vcc/2 | 2 X Vcc | 5, 10, 15, 30 pF | 5KΩ | 0.15V |
| 1.8 V±0.15 V | Vcc | ≤3ns | Vcc/2 | 2 X Vcc | 5, 10, 15, 30 pF | 5KΩ | 0.15V |
| 2.5 V±0.2 V | Vcc | ≤3ns | Vcc/2 | 2 X Vcc | 5, 10, 15, 30 pF | 5KΩ | 0.15V |
| 3.3 V±0.3 V | Vcc | ≤3ns | Vcc/2 | 2 X Vcc | 5, 10, 15, 30 pF | 5KΩ | 0.3V |



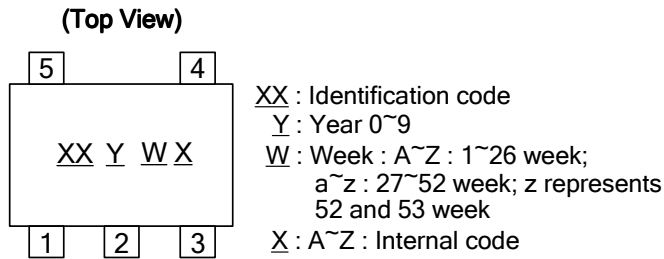
Voltage Waveform Propagation Delay Times Inverting and Non Inverting Outputs

Figure 1 Load Circuit and Voltage Waveforms

- Notes:
- A. Includes test lead and test apparatus capacitance.
 - B. All pulses are supplied at pulse repetition rate ≤ 10MHz.
 - C. Inputs are measured separately one transition per measurement.
 - D. t_{PLH} and t_{PHL} are the same as t_{PD} .

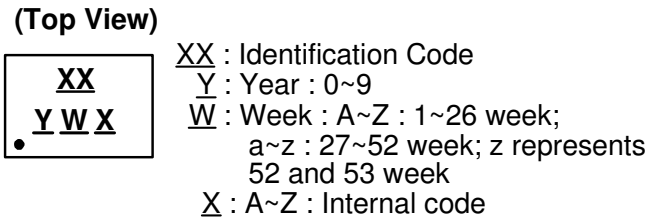
Marking Information

(1) SOT353



| Part Number | Package | Identification Code |
|-------------|---------|---------------------|
| 74AUP1G09SE | SOT353 | XR |

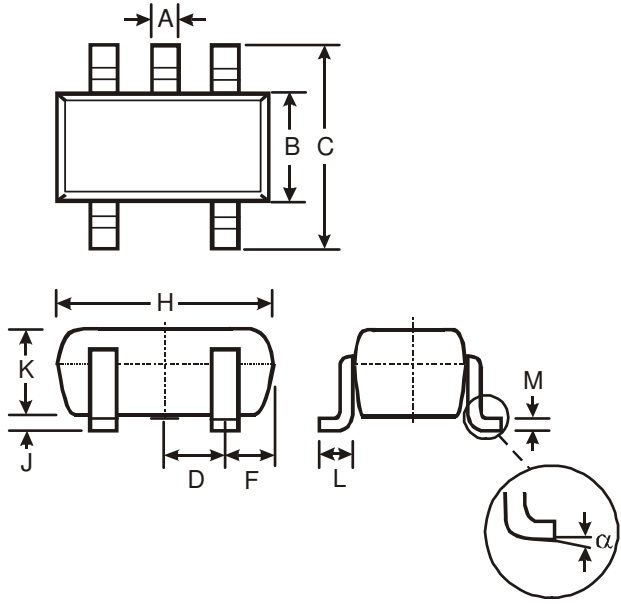
(2) X2-DFN0808-4, X1-DFN1010-6, X2-DFN1010-6, X2-DFN1409-6 and X2-DFN1410-6



| Part Number | Package | Identification Code |
|--------------|--------------|---------------------|
| 74AUP1G09FS3 | X2-DFN0808-4 | YU |
| 74AUP1G09FW5 | X1-DFN1010-6 | Q8 |
| 74AUP1G09FW4 | X2-DFN1010-6 | XR |
| 74AUP1G09FX4 | X2-DFN1409-6 | HG |
| 74AUP1G09FZ4 | X2-DFN1410-6 | XR |

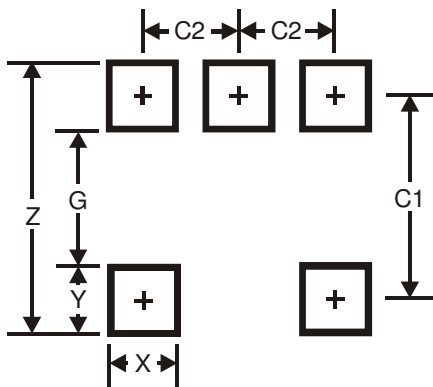
SOT353 Package Outline Dimensions and Suggested Pad Layout

Please see AP02002 at <http://www.diodes.com/datasheets/ap02002.pdf> for the latest version.



| SOT353 | | | |
|--------|----------|------|-------|
| Dim | Min | Max | Typ |
| A | 0.10 | 0.30 | 0.25 |
| B | 1.15 | 1.35 | 1.30 |
| C | 2.00 | 2.20 | 2.10 |
| D | 0.65 Typ | | |
| F | 0.40 | 0.45 | 0.425 |
| H | 1.80 | 2.20 | 2.15 |
| J | 0 | 0.10 | 0.05 |
| K | 0.90 | 1.00 | 1.00 |
| L | 0.25 | 0.40 | 0.30 |
| M | 0.10 | 0.22 | 0.11 |
| α | 0° | 8° | - |

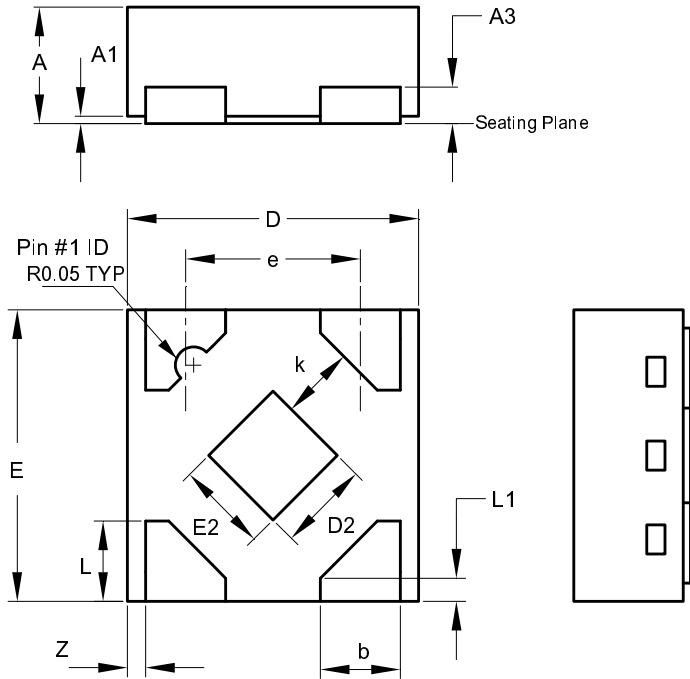
All Dimensions in mm



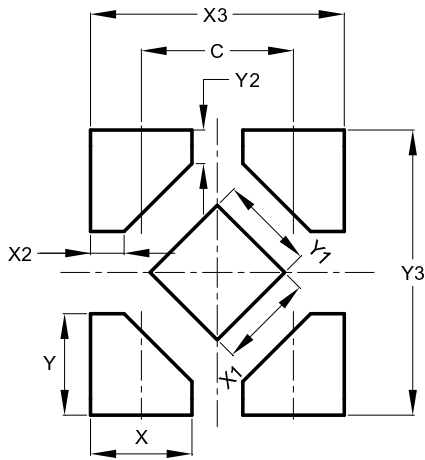
| Dimensions | Value (in mm) |
|------------|---------------|
| Z | 2.5 |
| G | 1.3 |
| X | 0.42 |
| Y | 0.6 |
| C1 | 1.9 |
| C2 | 0.65 |

X2-DFN0808-4 Package Outline Dimensions and Suggested Pad Layout

Please see AP02002 at <http://www.diodes.com/datasheets/ap02002.pdf> for the latest version.



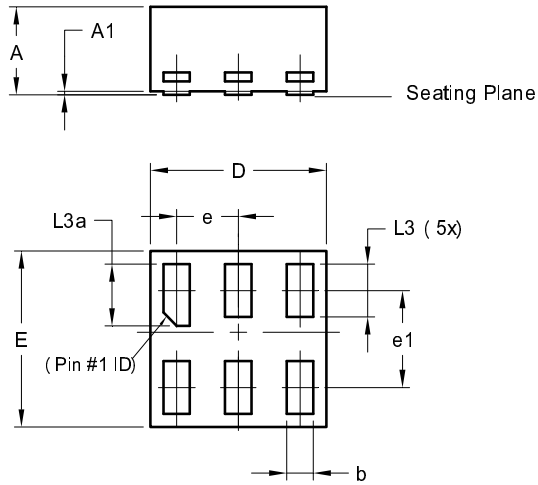
| X2-DFN0808-4 | | | |
|----------------------|------|------|------|
| Dim | Min | Max | Typ |
| A | 0.25 | 0.35 | 0.30 |
| A1 | 0 | 0.04 | 0.02 |
| A3 | - | - | 0.13 |
| b | 0.17 | 0.27 | 0.22 |
| D | 0.75 | 0.85 | 0.80 |
| D2 | 0.15 | 0.35 | 0.25 |
| E | 0.75 | 0.85 | 0.80 |
| E2 | 0.15 | 0.35 | 0.25 |
| e | - | - | 0.48 |
| K | 0.20 | - | - |
| L | 0.17 | 0.27 | 0.22 |
| L1 | 0.02 | 0.12 | 0.07 |
| Z | - | - | 0.05 |
| All Dimensions in mm | | | |



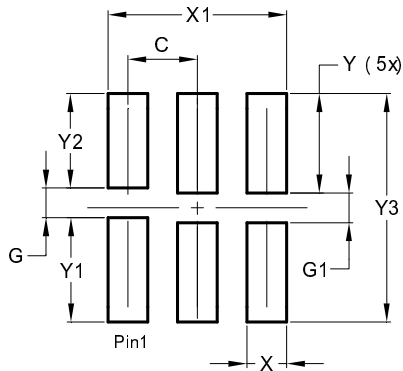
| Dimensions | Value |
|------------|-------|
| C | 0.480 |
| X | 0.320 |
| X1 | 0.300 |
| X2 | 0.106 |
| X3 | 0.800 |
| Y | 0.320 |
| Y1 | 0.300 |
| Y2 | 0.106 |
| Y3 | 0.900 |

X1-DFN1010-6 Package Outline Dimensions and Suggested Pad Layout

Please see AP02002 at <http://www.diodes.com/datasheets/ap02002.pdf> for the latest version.



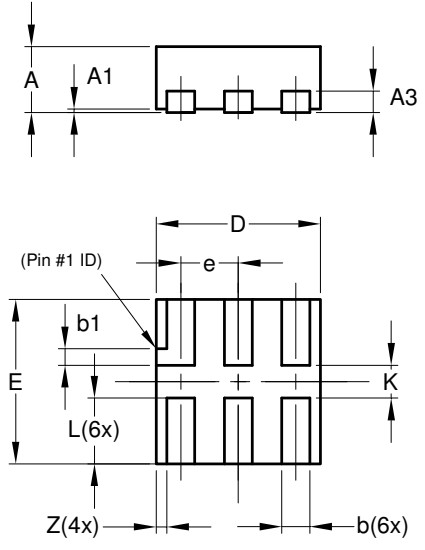
| X1-DFN1010-6 | | | |
|-----------------------------|----------|-------|------|
| Dim | Min | Max | Typ |
| A | - | 0.50 | 0.39 |
| A1 | - | 0.04 | - |
| b | 0.12 | 0.20 | 0.15 |
| D | 0.95 | 1.050 | 1.00 |
| E | 0.95 | 1.050 | 1.00 |
| e | 0.35 BSC | | |
| e1 | 0.55 BSC | | |
| L3 | 0.27 | 0.30 | 0.30 |
| L3a | 0.32 | 0.40 | 0.35 |
| All Dimensions in mm | | | |



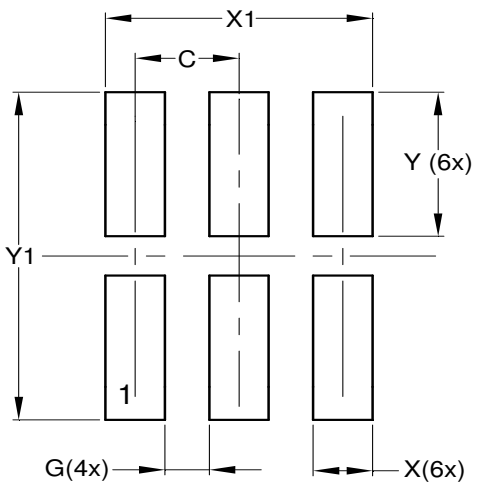
| Dimensions | Value (in mm) |
|------------|---------------|
| C | 0.350 |
| G | 0.150 |
| G1 | 0.150 |
| X | 0.200 |
| Y | 0.500 |
| Y1 | 0.525 |
| Y2 | 0.475 |
| Y3 | 1.150 |

X2-DFN1010-6 Package Outline Dimensions and Suggested Pad Layout

Please see AP02002 at <http://www.diodes.com/datasheets/ap02002.pdf> for the latest version.



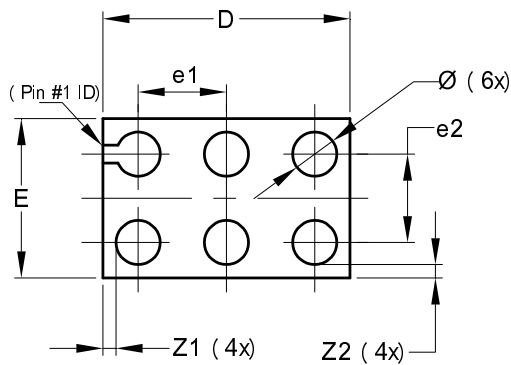
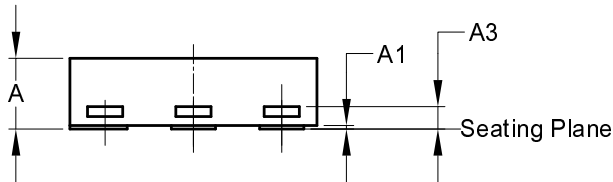
| X2-DFN1010-6 | | | |
|----------------------|------|------|-------|
| Dim | Min | Max | Typ |
| A | — | 0.40 | 0.39 |
| A1 | 0.00 | 0.05 | 0.02 |
| A3 | — | — | 0.13 |
| b | 0.14 | 0.20 | 0.17 |
| b1 | 0.05 | 0.15 | 0.10 |
| D | 0.95 | 1.05 | 1.00 |
| E | 0.95 | 1.05 | 1.00 |
| e | — | — | 0.35 |
| L | 0.35 | 0.45 | 0.40 |
| K | 0.15 | — | — |
| Z | — | — | 0.065 |
| All Dimensions in mm | | | |



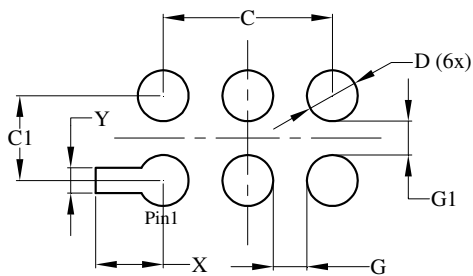
| Dimensions | Value (in mm) |
|------------|---------------|
| C | 0.350 |
| G | 0.150 |
| X | 0.200 |
| X1 | 0.900 |
| Y | 0.550 |
| Y1 | 1.250 |

X2-DFN1409-6 Package Outline Dimensions and Suggested Pad Layout

Please see AP02002 at <http://www.diodes.com/datasheets/ap02002.pdf> for the latest version.



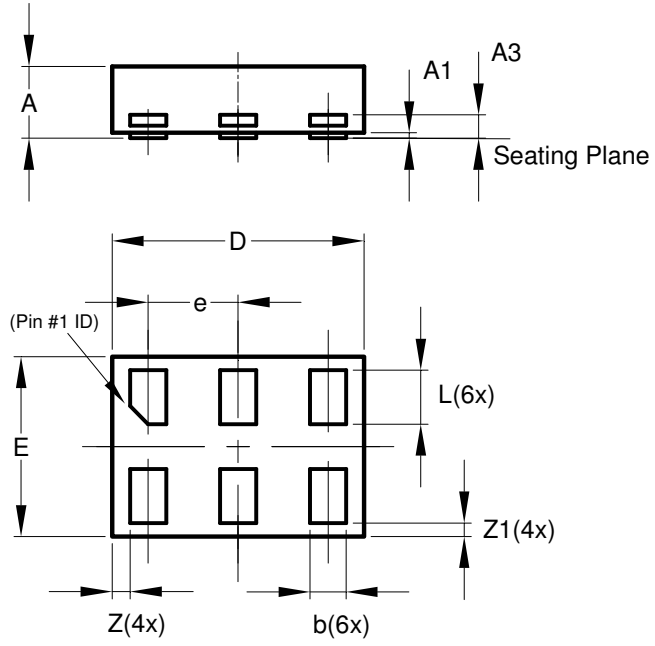
| X2-DFN1409-6 | | | |
|----------------------|------|------|-------|
| Dim | Min | Max | Typ |
| A | - | 0.40 | 0.39 |
| A1 | 0 | 0.05 | 0.02 |
| A3 | - | - | 0.13 |
| Ø | 0.20 | 0.30 | 0.25 |
| D | 1.35 | 1.45 | 1.40 |
| E | 0.85 | 0.95 | 0.90 |
| e1 | - | - | 0.50 |
| e2 | - | - | 0.50 |
| Z1 | - | - | 0.075 |
| Z2 | - | - | 0.075 |
| All Dimensions in mm | | | |



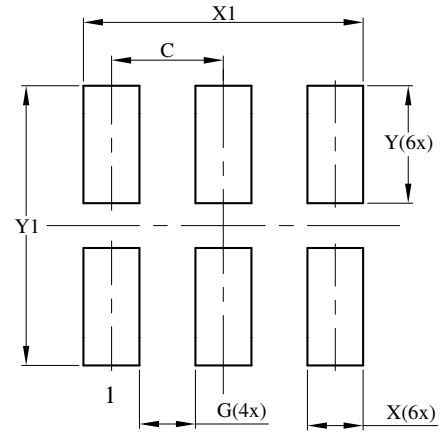
| Dimensions | Value (in mm) |
|------------|---------------|
| C | 1.000 |
| C1 | 0.500 |
| D | 0.300 |
| G | 0.200 |
| G1 | 0.200 |
| X | 0.400 |
| Y | 0.150 |

X2-DFN1410-6 Package Outline Dimensions and Suggested Pad Layout

Please see AP02002 at <http://www.diodes.com/datasheets/ap02002.pdf> for the latest version.



| X2-DFN1410-6 | | | |
|----------------------|-------|-------|-------|
| Dim | Min | Max | Typ |
| A | — | 0.40 | 0.39 |
| A1 | 0.00 | 0.05 | 0.02 |
| A3 | — | — | 0.13 |
| b | 0.15 | 0.25 | 0.20 |
| D | 1.35 | 1.45 | 1.40 |
| E | 0.95 | 1.05 | 1.00 |
| e | — | — | 0.50 |
| L | 0.25 | 0.35 | 0.30 |
| Z | — | — | 0.10 |
| Z1 | 0.045 | 0.105 | 0.075 |
| All Dimensions in mm | | | |



| Dimensions | Value (in mm) |
|------------|---------------|
| C | 0.500 |
| G | 0.250 |
| X | 0.250 |
| X1 | 1.250 |
| Y | 0.525 |
| Y1 | 1.250 |

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